IN THE UNITED STATES PATENT AND TRADEMARK OFFICE 122 (F(NE))
application of
et al.
: 09/666,325 Group Art Unit: 2811
tember 21, 2000 Examiner: Kang, D.

LF-ALIGNED COPPER SILICIDE FORMATION FOR IMPROVED
OHESION/GLECTROMIGRATION

In re patent application of

Armbrust et al.

Serial No.: 09/666,325

Filed: September 21, 2000

For:

SELF-ALIGNED COPPER SILICIDE FORMATION FOR IMPROVED

ADHESION/ELECTROMIGRATION

Assistant Commissioner of Patents

Box AF

Washington, D.C. 20231

SECOND AMENDMENT UNDER 37 C.F.R. §1.116

Sir:

In response to the final Office Action mailed November 18, 2002, please amend the application as follows.

IN THE CLAIMS:

Please cancel claims 15-20 without prejudice or disclaimer.

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CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8) Applicant(s): Armbrust et al.			Docket No. 8U9-98-110 DIV	
Serial No. 09/666,325	Filing Date September 21, 2000	Examiner D. Kang	Group Art Unit 2811	
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